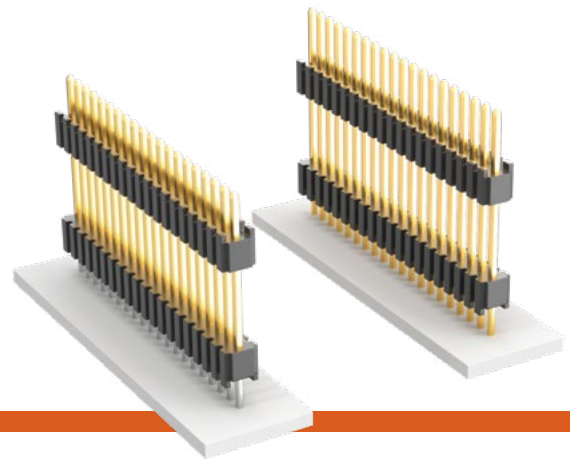


MICRO BOARD STACKER

(1.27 mm) .050" PITCH • DWM/HDWM SERIES



DWM/HDWM

Mates:
SMS, SLM, RSM

SPECIFICATIONS

Insulator Material:
Liquid Crystal Polymer
Terminal Material:
Phosphor Bronze
Plating:
Au or Sn over 50 μ " (1.27 μ m) Ni
Operating Temp Range:
-55 °C to +105 °C with Tin
-55 °C to +125 °C with Gold

PROCESSING

Lead-Free Solderable:
Yes
SMT Lead Coplanarity:
(0.15 mm) .006" max*
*(.004" stencil solution may be available; contact ipg@samtec.com)

ALSO AVAILABLE

Other Platings
(MOQ Required)

DWM	NO. PINS PER ROW	LEAD STYLE	PLATING OPTION	ROW OPTION	STACKER HEIGHT	OTHER OPTION
	01 thru 50	Specify LEAD STYLE from chart	-L = 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail -G = 10 μ" (0.25 μm) Gold on contact, Gold flash on tail	-S = Single Row -D = Double Row	- "XXX" = Stacker Height Example: -200 = (5.08 mm) .200"	- "XXX" = Polarized Position (Specify position of omitted pin)
